



# **Section 5. Flash Programming**

#### **HIGHLIGHTS**

This section of the manual contains the following major topics:

5.1	Introduction	5-2
5.2	Table Instruction Operation	5-2
5.3	Control Registers	5-5
5.4	Run-Time Self-Programming (RTSP)	5-9
5.5	Register Map	5-17
5.6	Related Application Notes	5-18
	Revision History	

# dsPIC33E/PIC24E Family Reference Manual

#### Note:

This family reference manual section is meant to serve as a complement to device data sheets. Depending on the device variant, this manual section may not apply to all dsPIC33E/PIC24E devices.

Please consult the note at the beginning of the "Flash Program Memory" chapter in the current device data sheet to check whether this document supports the device you are using.

Device data sheets and family reference manual sections are available for download from the Microchip Worldwide Web site at: http://www.microchip.com

#### 5.1 INTRODUCTION

This section describes the technique for programming Flash program memory. The dsPIC33E/PIC24E family of devices have an internal programmable Flash program memory for execution of user code. There are two methods to program this memory:

- · Run-Time Self-Programming (RTSP)
- In-Circuit Serial Programming™ (ICSP™)

This section describes RTSP programming, which is performed by the user's software.

ICSP is performed using a serial data connection to the device and allows for faster programming than RTSP. The ICSP protocol is defined in the "dsPIC33E/PIC24E Flash Programming Specification" (DS70619), which can be downloaded from the Microchip web site.

#### 5.2 TABLE INSTRUCTION OPERATION

The table instructions provide the method of transferring data between the Flash program memory space and the data memory space of dsPIC33E/PIC24E devices. This section provides a summary of the table instructions used during programming of the Flash program memory. There are four basic table instructions:

- TBLRDL: Table Read Low
- TBLRDH: Table Read High
- TBLWTL: Table Write Low
- TBLWTH: Table Write High

The TBLRDL instruction is used to read from bits <15:0> of program memory space. The TBLWTL instruction is used to write to bits <15:0> of Flash program memory space. TBLRDL and TBLWTL can access Flash program memory in Word mode or Byte mode.

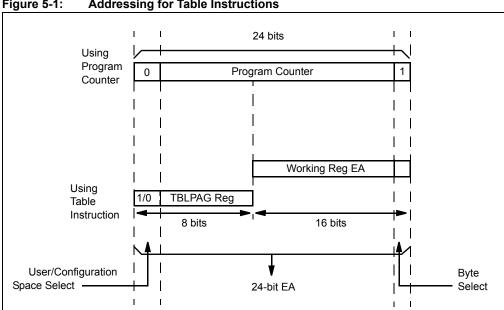
The TBLRDH and TBLWTH instructions are used to read or write to bits <23:16> of program memory space. TBLRDH and TBLWTH can access Flash program memory in Word or Byte mode. Because the Flash program memory is only 24 bits wide, the TBLRDH and TBLWTH instructions can address an upper byte of Flash program memory that does not exist. This byte is called the "phantom byte". Any read of the phantom byte will return 0x00. A write to the phantom byte has no effect.

The 24-bit Flash program memory can be regarded as two side-by-side 16-bit spaces, with each space sharing the same address range. Therefore, the TBLRDL and TBLWTL instructions access the "low" program memory space (PM<15:0>). The TBLRDH and TBLWTH instructions access the "high" program memory space (PM<31:16>). Any reads or writes to PM<31:24> will access the phantom (unimplemented) byte. When any of the table instructions are used in Byte mode, the Least Significant bit (LSb) of the table address will be used as the byte select bit. The LSb determines which byte in the high or low program memory space is accessed.

Figure 5-1 illustrates how the Flash program memory is addressed using the table instructions. A 24-bit program memory address is formed using bits <7:0> of the TBLPAG register and the effective address (EA) from a W register specified in the table instruction. The 24-bit program counter (PC) is illustrated in Figure 5-1 for reference. The upper 23 bits of the EA are used to select the Flash program memory location.

For the Byte mode table instructions, the LSb of the W register EA is used to select which byte of the 16-bit Flash program memory word is addressed. '1' selects bits <15:8> and '0' selects bits <7:0>. The LSb of the W register EA is ignored for a table instruction in Word mode.

In addition to the Flash program memory address, the table instruction also specifies a W register (or a W Register Pointer to a memory location), that is the source of the Flash program memory data to be written or the destination for a Flash program memory read. For a table write operation in Byte mode, bits <15:8> of the source working register are ignored.



**Addressing for Table Instructions** Figure 5-1:

#### 5.2.1 **Using Table Read Instructions**

Table reads require two steps:

- The address pointer is set up using the TBLPAG register and one of the W registers.
- The Flash program memory contents at the address location may be read.

#### **READ WORD MODE** 5.2.1.1

The code shown in Example 5-1, shows how to read a word of Flash program memory using the table instructions in Word mode.

#### Example 5-1: **Read Word Mode**

```
; Set up the address pointer to program space
              #tblpage(PROG ADDR),W0
   VOM
                                            ; get table page value
                                            ; load TBLPAG register
              W0, TBLPAG
   MOV
              #tbloffset(PROG ADDR),W0
                                            ; load address LS word
; Read the program memory location
                                             ; Read high byte to W3
   TBLRDH
              [W0],W3
   TBLRDL
               [WO],W4
                                             ; Read low word to W4
```

#### 5.2.1.2 READ BYTE MODE

The code shown in Example 5-2, shows the post-increment operator on the read of the low byte, which causes the address in the working register to increment by one. This sets EA<0> to a '1' for access to the middle byte in the third write instruction. The last post-increment sets W0 back to an even address, pointing to the next Flash program memory location.

#### Example 5-2: Read Byte Mode

```
; Set up the address pointer to program space
                                       ; get table page value
             #tblpage(PROG ADDR),W0
   MOV
             W0, TBLPAG
                                          ; load TBLPAG register
   MOV
            #tbloffset(PROG ADDR),W0
                                         ; load address LS word
; Read the program memory location
   TBLRDH.B [W0],W3
                                          ; Read high byte to W3
   TBLRDL.B [W0++],W4
                                          ; Read low byte to W4
   TBLRDL.B [W0++],W5
                                          ; Read middle byte to W5
```

#### 5.2.1.3 TABLE WRITE LATCHES

Table write instructions do not write directly to the nonvolatile program memory. Instead, the table write instructions load write latches that store the write data. The NVM address registers must be loaded with the first address where latched data should be written. When all of the write latches have been loaded, the actual memory programming operation is started by executing a special sequence of instructions. During programming, the hardware transfers the data in the write latches to Flash memory.

The write latches always start at address 0xFA0000 and extend through 0xFA0002 for word programming or through 0xFA00FE for devices which have row programming.

**Note:** The number of write latches varies by device. Refer to the "Flash Program Memory" chapter of the specific device data sheet for the number of available write latches.

#### 5.3 CONTROL REGISTERS

Several Special Function Registers (SFRs) are used to program the Flash program memory erase and write operations: NVMCON, NVMKEY and the NVM Address registers, NVMADR and NVMADRU.

#### 5.3.1 NVMCON Register

The NVMCON register is the primary control register for Flash and program/erase operations. This register selects whether an erase or program operation will be performed and can start the program or erase cycle.

The NVMCON register is shown in Register 5-1. The lower byte of NVMCON configures the type of NVM operation that will be performed.

#### 5.3.2 NVMKEY Register

The NVMKEY register (see Register 5-4) is a write-only register used to prevent accidental writes or erasures of the Flash memory. To start a programming or erase sequence, the following steps must be considered:

- 1. Write 0x55 to NVMKEY.
- 2. Write 0xAA to NVMKEY.
- 3. Start the programming write cycle by setting the WR bit (NVMCON<15>).
- 4. Execute two NOP instructions.

After this sequence, a write will be allowed to the NVMCON register for one instruction cycle. The user application needs to set the WR bit (NVMCON<15>) to start the program or erase cycle. Interrupts should be disabled during the unlock sequence. Example 5-3 shows how the unlock sequence is performed.

#### Example 5-3: NVMKEY Unlock Sequence

```
; if programming, load write latches
; Set NVM Address Registers
; Disable interrupts < priority 7 for next 5 instructions.
; Assumes no level 7 peripheral interrupts
   DIST
          #06
          #0x55, W0
   MOV
          WO, NVMKEY
   MOV
          #0xAA, W0
   MOV
          WO, NVMKEY
           NVMCON, #15
   BSET
                         ; Start the program/erase cycle
   NOP
```

Refer to 5.4.2 "Flash Programming Operations" for more programming examples.

#### 5.3.3 NVM Address Registers

The two NVM Address registers, NVMADRU and NVMADR, when concatenated, form the 24-bit EA of the selected row or word for programming operations. The NVMADRU register is used to hold the upper eight bits of the EA, and the NVMADR register is used to hold the lower 16 bits of the EA.

The NVM address registers should always point to a double instruction word boundary when performing a double instruction word programming operation, a row boundary when performing a row programming operation, or a page boundary when performing a page erase operation.

5

Programming

# dsPIC33E/PIC24E Family Reference Manual

#### Register 5-1: NVMCON: Flash Memory Control Register

R/SO-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
WR <sup>(1)</sup> WREN <sup>(1)</sup> WRERR <sup>(1)</sup> N		NVMSIDL <sup>(2)</sup>	_	_	_	_	
bit 15							bit 8

U-0	U-0	U-0	U-0	R/W-0	R/W-0						
_	_	_	_	NVMOP<3:0> <sup>(3,5)</sup>							
bit 7							bit 0				

Legend:	SO = Settable-only bit					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

- bit 15 WR: Write Control bit<sup>(1)</sup>
  - 1 = Initiates a Flash program memory or erase operation. The operation is self-timed and the bit is cleared by hardware once operation is complete
  - 0 = Program or erase operation is complete and inactive
- bit 14 WREN: Write Enable bit<sup>(1)</sup>
  - 1 = Enable Flash program memory/erase operations
  - 0 = Inhibit Flash program memory/erase operations
- bit 13 WRERR: Write Sequence Error Flag bit<sup>(1)</sup>
  - 1 = An improper program or erase sequence attempt or termination has occurred (bit is set automatically on any set attempt of the WR bit)
  - 0 = The program or erase operation completed normally
- bit 12 **NVMSIDL:** Stop in Idle Mode bit<sup>(2)</sup>
  - 1 = Discontinue Flash operation when the device enters Idle mode
  - 0 = Continue Flash operation when the device enters Idle mode
- bit 11-4 Unimplemented: Read as '0'
- bit 3-0 **NVMOP<3:0>:** NVM Operation Select bits<sup>(1,3,5)</sup>
  - 1111 = Reserved
  - 1110 = Reserved
  - 1101 = Bulk erase primary Flash program memory<sup>(4)</sup>
  - 1100 = Reserved
  - 1011 = Reserved
  - 1010 = Bulk erase auxiliary Flash program memory(4)
  - 0011 = Memory page erase operation
  - 0010 = Memory row program operation<sup>(4)</sup>
  - 0001 = Memory double word program operation
  - 0000 = Program a single Configuration register byte<sup>(4)</sup>
- Note 1: This bit can only be reset (i.e., cleared) on a Power-on Reset (POR).
  - 2: When exiting Idle mode, there is a power-up delay (TVREG) before Flash program memory becomes operational. Refer to the "Electrical Characteristics" chapter of the specific device data sheet for more information.
  - **3:** All other combinations of NVMOP<3:0> are unimplemented.
  - **4:** This functionality is not available on all devices. Refer to the **"Flash Program Memory"** chapter in the specific device data sheet for available operations.
  - **5:** Entry into a power-saving mode after executing a PWRSAV instruction is contingent on completion of all pending NVM operations.

#### Register 5-2: NVMADRU: Nonvolatile Memory Upper Address Register

U-0	U-0 U-0 U-0		U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x						
	NVMADRU<7:0>												
bit 7	bit 7 bit 0												

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 Unimplemented: Read as '0'

bit 7-0 NVMADRU<7:0>: Nonvolatile Memory Upper Write Address bits

Selects the upper eight bits of the location to program or erase in Flash program memory. This register

may be read or written by the user application.

#### Register 5-3: NVMADR: Nonvolatile Memory Address Register

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x					
NVMADR<15:8>												
bit 15 bit 8												

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x					
	NVMADR<7:0>											
bit 7 bi												

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 **NVMADR<15:0>:** Nonvolatile Memory Write Address bits

Selects the 16-bit offset of the location to program or erase in Flash program memory. This register

may be read or written by the user application.

**Note:** The NVM address register should always point to a double instruction word boundary when performing a double instruction word programming operation, a row boundary when performing a row programming operation, or a page boundary when performing a page erase operation.

5

# dsPIC33E/PIC24E Family Reference Manual

#### Register 5-4: NVMKEY: Nonvolatile Memory Key Register

U-0 U-0 U-0		U-0	U-0	U-0	U-0	U-0	
_	_	_	_	_	_	_	_
bit 15							bit 8

W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0				
NVMKEY<7:0>											
bit 7 bit											

**Legend:** SO = Settable-only bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-0 **NVMKEY<7:0>:** Key Register (write-only) bits

**Note:** Refer to **5.3.2 "NVMKEY Register"** for NVMKEY register operation.

# 5.4 RUN-TIME SELF-PROGRAMMING (RTSP)

RTSP allows the user application to modify Flash program memory contents. RTSP is accomplished using the  ${\tt TBLRD}$  (table read) and  ${\tt TBLWT}$  (table write) instructions, the TBLPAG register, and the NVM Control registers. With RTSP, the user application can erase a single page of Flash memory and program either two instruction words or up to 128 instruction words on certain devices.

#### 5.4.1 RTSP Operation

The dsPIC33E/PIC24E Flash program memory array is organized into erase pages that can contain up to 1024 instructions. The double word programming option is available in all devices in the dsPIC33E/PIC24E family. In addition, certain devices have row programming capability, which allows the programming of up to 128 instruction words at a time.

Programming and erase operations always occur on even double programming word, row, or page boundaries. Refer to the "Flash Program Memory" chapter of the specific device data sheet for the availability and sizes of a programming row and the page size for erasing.

The Flash program memory implements holding buffers, called write latches, that can contain up to 128 instructions of programming data depending on the device. Prior to the actual programming operation, the write data must be loaded into the write latches.

The basic sequence for RTSP is to set up the table pointer TBLPAG register, and then perform a series of TBLWT instructions to load the write latches. Programming is performed by setting the control bits in the NVMCON register. The number of TBLWTL and TBLWTH instructions needed to load the write latches is equal to the number program words to be written.

**Note:** It is recommended that the TBLPAG register be saved prior to modification, and restored after use.

#### **CAUTION**

On some devices, the Configuration bits are stored in the last page of program Flash user memory space in a section called "Flash Configuration Bytes". With these devices, performing a page erase operation on the last page of program memory erases the Flash Configuration bytes, which enables code protection. Therefore, users should not perform page erase operations on the last page of program memory. This is not a concern when the Configuration bits are stored in Configuration memory space in a section called "Device Configuration Registers". Refer to the Program Memory Map in the "Memory Organization" chapter of the specific device data sheet to determine where configuration bits are located.

#### 5.4.2 Flash Programming Operations

A program or erase operation is necessary for programming or erasing the internal Flash program memory in RTSP mode. The program or erase operation is automatically timed by the device (refer to the specific device data sheet for timing information). Setting the WR bit (NVMCON<15>) starts the operation. The WR bit is automatically cleared when the operation is finished.

The CPU stalls until the programming operation is finished. The CPU will not execute any instructions or respond to interrupts during this time. If any interrupts occur during the programming cycle, they will remain pending until the cycle completes.

Some dsPIC33E/PIC24E devices may provide auxiliary Flash program memory (refer to the "Memory Organization" chapter of specific device data sheet for details), which allows instruction execution without CPU stalls while user Flash program memory is being erased and/or programmed. Conversely, auxiliary Flash program memory can be programmed without CPU stall, as long as code is executed from the user Flash program memory. The NVM interrupt can be used to indicate that the programming operation is complete.

- **Note 1:** If a POR or BOR event occurs while an RTSP erase or programming operation is in progress, the RTSP operation is aborted immediately. The user should execute the RTSP operation again after the device comes out of reset.
  - 2: If an EXTR, SWR, WDTO, TRAPR, CM, or IOPUWR reset event occurs while an RTSP erase or programming operation is in progress, the device will be reset only after the RTSP operation is complete.

5

Programming

#### 5.4.2.1 RTSP PROGRAMMING ALGORITHM

This section describes RTSP programming, which consists of three major processes.

#### Creating a RAM Image of the Data Page to be Modified

Perform these two steps to create a RAM image of the data page to be modified:

- Read the page of Flash program memory and store it into data RAM as a data "image".
   The RAM image must be read starting from a page address boundary.
- 2. Modify the RAM data image as needed.

#### **Erasing Flash Program Memory**

After completing steps 1 and 2 above, perform the following four steps to erase the Flash program memory page:

- 1. Set the NVMOP<3:0> bits (NVMCON<3:0>) to erase the page of Flash program memory read from step 1.
- Write the starting address of the page to be erased into the NVMADRU and NMVADR registers.
- 3. With interrupts disabled:
  - a) Write the key sequence to the NVMKEY register to enable setting the WR bit (NVMCON<15>).
  - b) Set the WR bit. This will start the erase cycle.
  - c) Execute two NOP instructions.
- 4. The WR bit is cleared when the erase cycle is complete.

#### **Programming the Flash Memory Page**

The next part of the process is to program the Flash memory page. The Flash memory page is programmed using the data from the image created in step 1. The data is transferred to the write latches in increments of either double instruction words or rows. All devices have double instruction word programming capability. (Refer to the "Flash Program Memory" chapter in the specific device data sheet to determine if Row programming is available.) After the write latches are loaded, the programming operation is initiated, which transfers the data from the write latches into Flash memory. This is repeated until the entire page has been programmed.

Repeat the following three steps, starting at the first instruction word of the Flash page and incrementing in steps of either double program words or instruction rows until the entire page has been programmed:

- 1. Load the write latches:
  - a) Set the TBLPAG register to point to the location of the write latches.
  - b) Load the desired number of latches using pairs of TBLWTL and TBLWTH instructions:
    - For double word programming, two pairs of TBLWTL and TBLWTH instructions are required
    - For row programming, a pair of TBLWTL and TBLWTH instructions are required for each instruction word row element
- 2. Initiate the programming operation:
  - a) Set the NVMOP<3:0> bits (NVMCON<3:0>) to program either double instruction words or an instruction row as appropriate.
  - b) Write the first address of either the double instruction word or instruction row to be programmed into the NVMADRU and NVMADR registers.
  - c) With interrupts disabled:
    - Write the key sequence to the NVMKEY register to enable setting the WR bit (NVMCON<15>)
    - · Set the WR bit. This will start the erase cycle
    - · Execute two NOP instructions
- 3. The WR bit is cleared when the programming cycle is complete.

Repeat the entire process as needed, to program the desired amount of Flash program memory.

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When programming in the C language, several built-in functions are available that facilitate Flash programming. See the "MPLAB® 16-bit C Compiler for PIC24 MCUs and dsPIC® DSCs Users Guide" (DS51284) for details regarding:

- The builtin write NVM instruction, which writes the NVMKEY sequence
- · The suite of built-in table operations used to load the write latches
  - **Note 1:** The user should remember that the minimum amount of Flash program memory that can be erased using RTSP is a single erase page. Therefore, it is important that an image of these locations be stored in general purpose RAM before an erase cycle is initiated.
    - **2:** A row or word in Flash program memory should not be programmed more than twice before being erased.
    - **3:** On devices with Configuration bytes stored in the last page of Flash, performing a page erase operation on the last page of program memory clears the Configuration bytes, which enables code protection. On these devices, the last page of Flash memory should not be erased.

#### 5.4.2.2 ERASING ONE PAGE OF FLASH

The code sequence shown in Example 5-4 can be used to erase a page of Flash program memory. The NVMCON register is configured to erase one page of program memory. The NVMADR and NMVADRU registers are loaded with the starting address of the page to be erased. The program memory must be erased at an "even" page address boundary. See the "Flash Program Memory" chapter of the specific device data sheet to determine the size of the flash page.

The erase operation is initiated by writing a special unlock, or key sequence to the NVMKEY register before setting the WR bit (NVMCON<15>). The unlock sequence needs to be executed in the exact order, as shown in Example 5-4, without interruption; therefore, interrupts should be disabled.

Two NOP instructions should be inserted in the code after the erase cycle.

On certain devices, the Configuration bits are stored in the last page of program Flash. With these devices, performing a page erase operation on the last page of program memory erases the Flash Configuration bytes, enabling code protection as a result. Users should not perform page erase operations on the last page of program memory.

#### Example 5-4: Erasing a Page of Flash Program Memory

```
; Define the start address of the page to erase
      .equ PROG_ADDR, 0x022000
; Set up the NVMADR registers to the starting address of the page
       MOV #tblpage(PROG ADDR), WO
       MOV
            W0,NVMADRU
              #tbloffset(PROG_ADDR),W0
       MOV
       MOV
              W0,NVMADR
; Set up NVMCON to erase one page of Program Memory
       MOV
              #0x4003,W0
      MOV
              W0,NVMCON
; Disable interrupts < priority 7 for next 5 instructions
; Assumes no level 7 peripheral interrupts
            #06
; Write the KEY Sequence
       MOV #0x55,W0
       MOV
              W0,NVMKEY
       MOV
              #0xAA,W0
       MOV
              W0,NVMKEY
; Start the erase operation
       BSET NVMCON, #15
; Insert two NOPs after the erase cycle (required)
       NOP
```

#### 5.4.2.3 LOADING WRITE LATCHES

The write latches are used as a storage mechanism between the user application table writes and the actual programming sequence. During the programming operation, the device will transfer the data from the write latches into Flash memory.

For devices that support row programming, Example 5-5 shows the sequence of instructions that can be used to load 128 write latches (128 instruction words). 128 TBLWTL and 128 TBLWTH instructions are needed to load the write latches for programming a row of Flash program memory. Refer to the "Flash Program Memory" chapter of the specific device data sheet to determine the number of programming latches available on your device.

For devices that do not support row programming Example 5-6 shows the sequence of instructions that can be used to load two write latches (two instruction words). Two  $\mathtt{TBLWTL}$  and two  $\mathtt{TBLWTH}$  instructions are needed to load the write latches.

- Note 1: The code for Load\_Write\_Latch\_Row is shown in Example 5-5 and the code for Load\_Write\_Latch\_Word is shown in Example 5-6. The code in both of these examples is referred to in subsequent examples.
  - 2: Refer to the specific device data sheet for the number of latches.

#### Example 5-5: Loading Write Latches for Row Programming

```
Load Write Latch Row:
; This example loads 128 write latches
; W2 points to the address of the data to write to the latches
; Set up a pointer to the first latch location to be written
       MOV
              #0xFA,W0
       MOV
              W0, TBLPAG
       MOV
              #0,W1
; Perform the TBLWT instructions to write the latches
; W2 is incremented in the TBLWTH instruction to point to the
; next instruction location
       MOV
            #128,W3
   loop:
       TBLWTL.b [W2++], [W1++]
       TBLWTL.b [W2++], [W1--]
       TBLWTH.b
                  [W2++], [W1]
                  W1, W1
       INC2
       DEC
                  W3, W3
                  NZ, loop
       BRA
```

#### Example 5-6: Loading Write Latches for Double Word Programming

```
Load Write_Latch_Word:

; W2 points to the address of the data to write to the latches

; Set up a pointer to the first latch location to be written

MOV #0xFA,WO
MOV W0,TBLPAG
MOV #0,W1

; Perform the TBLWT instructions to write the latches

TBLWTL [W2++],[W1]
TBLWTH [W2++],[W1++]
TBLWTL [W2++],[W1++]
TBLWTL [W2++],[W1++]
```

#### 5.4.2.4 SINGLE ROW PROGRAMMING EXAMPLE

The NVMCON register is configured to program one row of Flash program memory. The program operation is initiated by writing a special unlock, or key sequence to the NVMKEY register before setting the WR bit (NVMCON<15>). The unlock sequence needs to be executed without interruption, and in the exact order, as shown in Example 5-7. Therefore, interrupts should be disabled prior to writing the sequence.

Two NOP instructions should be inserted in the code after the programming cycle.

#### Example 5-7: Single Row Programming

```
; Define the address from where the programming has to start
       .equ PROG ADDR, 0x022000
; Load the NVMADR register with the starting programming address
      MOV #tblpage(PROG ADDR), W9
      MOV
             #tbloffset(PROG_ADDR),W8
            W9,NVMADRU
      MOV
      MOV
             W8,NVMADR
; Setup NVMCON to write 1 row of program memory
      MOV #0x4002,W0
      MOV
           WO.NVMCON
; Load the program memory write latches
      CALL Load Write Latch Row
; Disable interrupts < priority 7 for next 5 instructions
; Assumes no level 7 peripheral interrupts
      DISI
            #06
; Write the KEY sequence
      MOV
             #0x55,W0
             W0,NVMKEY
      MOV
           #0xAA,W0
      MOV
      MOV W0, NVMKEY
; Start the programming sequence
      BSET NVMCON, #15
; Insert two NOPs after programming
       NOP
```

**Note:** Not all devices have row programming capability. Refer to the "Flash Program Memory" chapter of the specific device data sheet to determine if this option is available.

5

#### 5.4.2.5 WORD PROGRAMMING

The NVMCON register is configured to program two instruction words of Flash program memory. The program operation is initiated by writing a special, unlock, or key sequence to the NVMKEY register before setting the WR bit (NVMCON<15>). The unlock sequence needs to be executed in the exact order, as shown in Example 5-8, without interruption. Therefore, interrupts should be disabled prior to writing the sequence.

Two  ${\tt NOP}$  instructions should be inserted in the code after the programming cycle.

#### Example 5-8: Programming Two Words of Flash Memory

```
; Define the address from where the programming has to start
.equ PROG ADDR, 0x022000;
; Load the destination address to be written
      MOV #tblpage(PROG ADDR), W9
      MOV #tbloffset (PROG ADDR), W8
       MOV W9, NVMADRU
      MOV W8, NVMADR;
; Load the two words into the latches
      CALL Load Write Latch Word
; Setup NVMCON for word programming
      MOV #0x4001,W0
      VOM
             W0, NVMCON
; Disable interrupts < priority 7 for next 5 instructions
; Assumes no level 7 peripheral interrupts
      DISI
              #06
; Write the key sequence
      MOV #0x55,W0
       MOV WO, NVMKEY
      MOV #0xAA,W0
      MOV
             W0,NVMKEY
; Start the write cycle
             NVMCON, #15
       BSET
       NOP
       NOP
```

# 5.4.3 Writing to Device Configuration Registers

On certain devices, the Configuration bits are stored in configuration memory space in a section called "Device Configuration Registers". On other devices, the Configuration bits are stored in the last page of program Flash user memory space in a section called "Flash Configuration Bytes". With these devices, performing a page erase operation on the last page of program memory erases the Flash Configuration bytes, which enables code protection. Therefore, users should not perform page erase operations on the last page of program memory. Refer to the Program Memory Map in the "Memory Organization" chapter of the specific device data sheet to determine where Configuration bits are located.

When the configuration bits are stored in Configuration memory space, RTSP can be used to write to the device Configuration registers, and RTSP allows each Configuration register to be individually rewritten without first performing an erase cycle. Caution must be exercised when writing the Configuration registers since they control critical device operating parameters, such as the system clock source, PLL and WDT enable.

The procedure for programming a device Configuration register is similar to the procedure for programming Flash program memory, except that only <code>TBLWTL</code> instructions are required. This is because the upper eight bits in each device Configuration register are unused. Furthermore, bit 23 of the table write address must be set to access the Configuration registers. Refer to **Section 30. "Device Configuration"** (DS70618) in the "dsPIC33E/PIC24E Family Reference Manual" and the "**Special Features**" chapter in the specific device data sheet for a full description of the device Configuration registers.

- **Note 1:** Writing to device Configuration registers is not available in all devices. Refer to the "**Special Features**" chapter in the specific device data sheet to determine the modes that are available according to the device-specific NVMOP<3:0> bits definition.
  - 2: While performing RTSP on device Configuration registers, the device must be operating using the Internal FRC Oscillator (without PLL). If the device is operating from a different clock source, a clock switch to the Internal FRC Oscillator (NOSC<2:0> = 000) must be performed prior to performing RTSP operation in the device Configuration registers.
  - **3:** If the Primary Oscillator Mode Select bits (POSCMD<1:0>) in the Oscillator Configuration register (FOSC) are being reprogrammed to a new value, the user must ensure that the Clock Switching Mode bits (FCKSM<1:0>) in the FOSC register have an initial programmed value of '0', prior to performing this RTSP operation.

5

#### 5.4.3.1 CONFIGURATION REGISTER WRITE ALGORITHM

The general procedure is as follows:

- 1. Write the new configuration value to the table write latch using a TBLWTL instruction.
- 2. Configure NVMCON for a Configuration register write (NVMCON = 0x4000).
- 3. Disable interrupts, if enabled.
- 4. Write the address of the Configuration register to be programmed into the NVMADRU and NVMADR registers.
- 5. Write the key sequence to the NVMKEY register.
- 6. Start the write sequence by setting the WR bit (NVMCON<15>).
- 7. Re-enable interrupts, if needed.

Example 5-9 shows the code sequence that can be used to modify a device Configuration register.

#### **Example 5-9: Configuration Register Write Code Example**

```
; Define the address to be written
       .equ DestinationAddress, 0xF80000
; Initialize the write pointer for writing to the latches
      MOV #0x0000, W7
; Initialize TBLPAG register for writing to the latches
             #0xFA, W12
      MOV
              W12, TBLPAG
; Get the new data to write to the configuration register
             #ConfigValue,W1
      VOM
: Perform the table write to load the write latch
      TBLWTL W1, [W7]
; Load the address which is to be programmed
      MOV
            #DestinationAddress<15:0>,W2
             #DestinationAddress<23:16>,W3
      MOV
      MOV W3, NVMADRU
      MOV W2, NVMADR
; Configure NVMCON for a configuration register write
      MOV #0x4000,W0
      MOV
             W0,NVMCON
; Disable interrupts < priority 7 for next 5 instructions
; Assumes no level 7 peripheral interrupts
       DISI #06
; Write the KEY sequence
      MOV #0x55,W0
            W0,NVMKEY
      VOM
             #0xAA,W0
             W0,NVMKEY
      MOV
; Start the programming sequence
      BSET
             NVMCON, #15
 Insert two NOPs after programming
       NOP
       NOP
```

DS70609D-page 5-17

# Section 5. Flash Programming

#### 5.5 REGISTER MAP

A summary of the registers associated with Flash Programming is provided in Table 5-1.

Table 5-1: Flash Programming Registers

File Name	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
NVMCON	WR	WREN	WRERR	NVMSIDL	_	_	_	_	_	_	_	_		0000			
NVMADRU	-	_	_	1	1	_	_	_	NVMADRU<7:0>								0000
NVMADR	NVMADR<15:0>													0000			
NVMKEY	_	_	_	_	-	_	_	_	NVMKEY<7:0>								0000

**Legend:** x = x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: Not all bits are available for all devices. Refer to the specific device data sheet for details.

#### 5.6 RELATED APPLICATION NOTES

This section lists application notes that are related to this section of the manual. These application notes may not be written specifically for the dsPIC33E/PIC24E product families, but the concepts are pertinent and could be used with modification and possible limitations. The current application notes related to Flash Programming are:

Title Application Note #

No related application notes at this time

N/A

**Note:** Please visit the Microchip web site (www.microchip.com) for additional Application Notes and code examples for the dsPIC33E/PIC24E family of devices.

#### 5.7 REVISION HISTORY

#### Revision A (August 2009)

This is the initial released version of this document.

#### **Revision B (February 2011)**

This revision includes the following updates:

- · Examples:
  - Removed Example 5-3 and Example 5-4
  - Updated Example 5-4, Example 5-7 and Example 5-9
  - Any references to #WR were updated to #15 in Example 5-4, Example 5-7 and Example 5-8
  - Updated the following in Example 5-5:
    - Updated the title "Word Programming" to "Loading Write Latches for Row Programming"
    - Any reference to #ram image was updated to #0xFA
  - Added Example 5-6
  - Updated the title in Example 5-8
- · Notes:
  - Added two notes in 5.4.2 "Flash Programming Operations"
  - Updated the note in 5.4.2.3 "Loading Write Latches"
  - Added three notes in 5.4.3 "Writing to Device Configuration Registers"
  - Added Note 1 in Table 5-1
- · Registers:
  - Updated the bit values for NVMOP<3:0>: NVM Operation Select bits in the Flash Memory Control (NVMCON) register (see Register 5-1)
- · Sections:
  - Removed sections 5.2.1.4 "Write Word Mode" and 5.2.1.5 "Write Byte Mode"
  - Updated 5.3 "Control Registers"
  - Updated the following in 5.4.2.5 "Word Programming":
    - Changed the section title "Programming One Word of Flash Memory" to "Word Programming"
    - · Updated the first paragraph
    - Changed the terms "one word" to "a pair of words" in the second paragraph
  - Added a new Step 1 to 5.4.3.1 "Configuration Register Write Algorithm"
- · Tables:
  - Updated Table 5-1
- A few references to program memory were updated to Flash program memory
- Other minor updates such as language and formatting updates were incorporated throughout the document

5

# dsPIC33E/PIC24E Family Reference Manual

#### Revision C (June 2011)

This revision includes the following updates:

- · Examples:
  - Updated Example 5-4
  - Updated Example 5-8
- · Notes:
  - Added a note in 5.4.1 "RTSP Operation"
  - Added Note 3 in 5.4.2 "Flash Programming Operations"
  - Added Note 3 in 5.4.2.1 "RTSP Programming Algorithm"
  - Added a note in 5.4.2.2 "Erasing One Page of Flash"
  - Added Note 2 in 5.4.2.3 "Loading Write Latches"
- · Registers:
  - Updated the bit description for bits 15-0 in the Nonvolatile Memory Address register (see Register 5-3)
- · Sections:
  - Updated 5.4.1 "RTSP Operation"
  - Updated 5.4.2.5 "Word Programming"
- Other minor updates such as language and formatting updates were incorporated throughout the document

#### Revision D (December 2011)

This revision includes the following updates:

- Updated 5.2.1.3 "Table Write Latches"
- Updated 5.3.2 "NVMKEY Register"
- Updated the notes in NVMCON: Flash Memory Control Register (see Register 5-1)
- Extensive updates were made throughout 5.4 "Run-Time Self-Programming (RTSP)"
- Other minor updates such as language and formatting updates were incorporated throughout the document

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